ROHM EMB6 / UMB6N

General purpose (dual digital transistor)

		●Outline
Parameter	DTr1 and DTr2	SOT-563 SOT-363
V <sub>CC</sub>	-50V	
I <sub>C(MAX.)</sub>	-100mA	
R <sub>1</sub>	47kΩ	EMB6 UMB6N
R <sub>2</sub>	47kΩ	(EMT6) (UMT6)
<ul> <li>Features</li> <li>1)Two DTA144E chips package.</li> <li>2)Mounting possible with automatic mounting m</li> <li>3)Transistor elements a eliminating interference</li> <li>4)Mounting cost and are</li> </ul> •Application INVERTER, INTERFACE	th EMT3 or UMT3 nachines. are independent, ce. ea can be cut in half	<ul> <li>● Inner circuit</li> <li>(1) DTr1 CND(Emitter)</li> <li>(2) DT2 CND(Emitter)</li> <li>(3) DT2 IN(Base)</li> <li>(4) DT12 OUT(Collector)</li> <li>(5) DTr1 IN(Base)</li> <li>(6) 0 Tr1 0 UT(Collector)</li> <li>(7) 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0</li></ul>

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMB6	SOT-563 (EMT6)	1616	T2R	180	8	8000	B6
UMB6N	SOT-363 (UMT6)	2021	TR	180	8	3000	B6

## • Absolute maximum ratings (T<sub>a</sub> = 25°C)

## <For DTr1 and DTr2 in common>

			-			
Pa	arameter		Symbol	Values	Unit	
Supply voltage		V <sub>CC</sub>	-50	V		
Input voltage			V <sub>IN</sub>	-40 to 10	V	
Output current			Ι <sub>Ο</sub>	-30	mA	
Collector current			I <sub>C(MAX)</sub> *1	-100	mA	
Power dissipation	EMB6		P <sub>D</sub> *2*3	150	-mW/Tota	
	UMB6N		P <sub>D</sub> *2*3	150		
Junction temperature			Tj	150	°C	
Range of storage temperat	ture		T <sub>stg</sub>	-55 to +150	°C	
<ul> <li>Electrical characteristic</li> <li>For DTr1 and DTr2 ir</li> </ul>	( 2 )	C				
				Values		

## • Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions		Values		Unit
	Symbol	Conditions	Min.	Тур.	Max.	
Inputivoltago	V <sub>I(off)</sub>	V <sub>CC</sub> = -5V, I <sub>O</sub> = -100μA	-	-	-0.5	V
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = -0.3V, I <sub>O</sub> = -2mA	-3.0	-	-	V
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = -10mA, I <sub>I</sub> = -0.5mA	-	-100	-300	mV
Input current	l <sub>l</sub>	V <sub>1</sub> = -5V	-	-	-180	μA
Output current	I <sub>O(off)</sub>	V <sub>CC</sub> = -50V, V <sub>I</sub> = 0V	-	-	-500	nA
DC current gain	G	V <sub>O</sub> = -5V, I <sub>O</sub> = -5mA	68	-	-	-
Input resistance	R <sub>1</sub>	-	32.9	47	61.1	kΩ
Resistance ratio	$R_2/R_1$	-	0.8	1.0	1.2	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	250	-	MHz

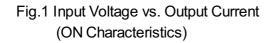
\*1 Characteristics of built-in transistor.

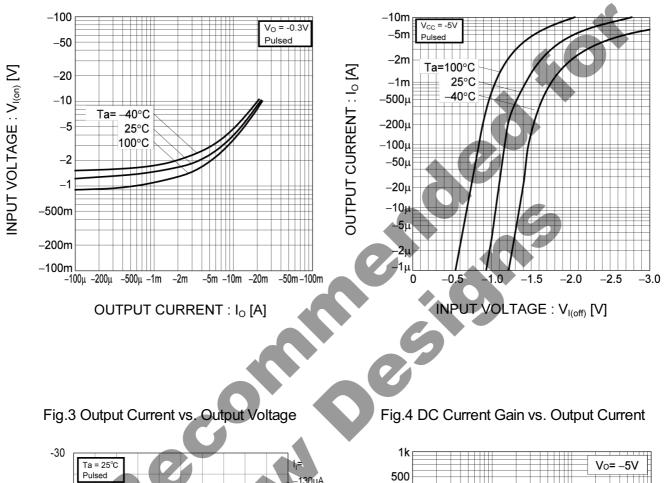
\*2 Each terminal mounted on a reference land.

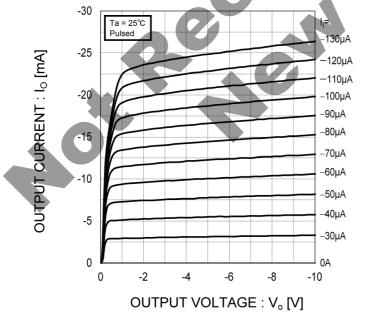
\*3 120mW per element must not be exceeded.



## •Electrical characteristic curves (T<sub>a</sub> = 25°C) <For DTr1 and DTr2 in common>







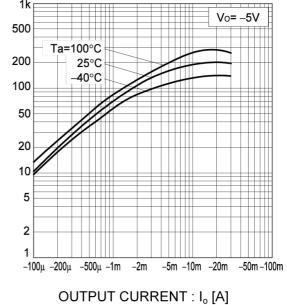


Fig.2 Output Current vs. Input Voltage

(OFF Characteristics)

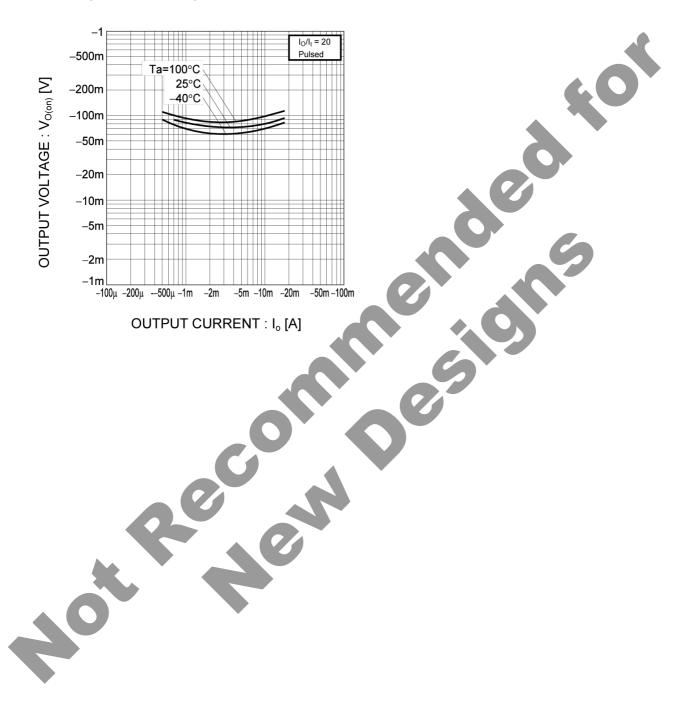


DC CURRENT GAIN : G

## •Electrical characteristic curves (T<sub>a</sub> = 25°C)

<For DTr1 and DTr2 in common>

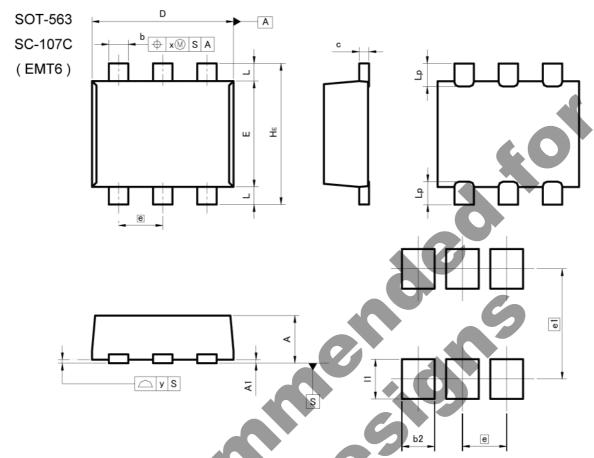
Fig.5 Output Voltage vs. Output Current





## EMB6 / UMB6N

## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

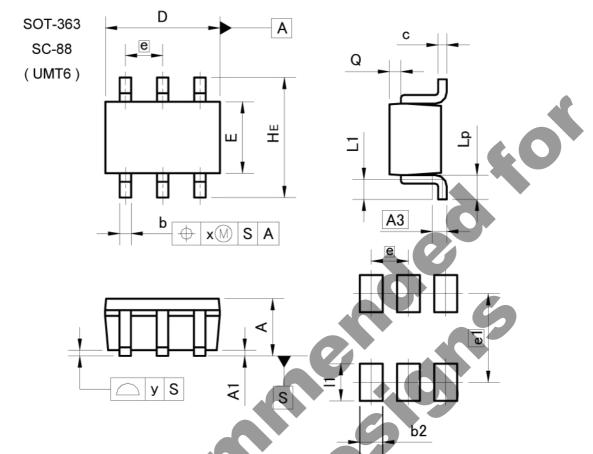
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
0	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	1.10	1.30	0.043	0.051
е	0.	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.10	0.30	0.004	0.012
Lp	_	0.35	-	0.014
x		0.10	-	0.004
У		0.10	-	0.004
DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	-	0.015
e1	1.	25	0.0	49
11		0.45	Ξ.	0.018





## EMB6 / UMB6N

## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

		ETERS	INC		
DIM					
	MIN	MAX	MIN	MAX	
A	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	0.:	25	0.0	10	
b	0.15	0.30	0.006	0.012	
c	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
e	0.	65	0.026		
HE	2.00	2.20	0.079	0.087	
L1	0.20	0.50	0.008	0.020	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
x	-	0.10	-	0.004	
У	-	0.10	. <del></del>	0.004	

DIM	MILIM	ETERS	INCHES		
	MIN	MAX	MIN	MAX	
b2	-	0.40	-	0.016	
e1	1.	55	0.061		
1	-	0.65	-	0.026	

Dimension in mm/inches

20%



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Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, 1. OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical E	quipment Classifi	cation of the Spec	ific Applications
JAPAN	USA	EU	CHINA

JAPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSI	
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI	

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products. 5.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, 6. confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.

- Confirm that operation temperature is within the specified range described in the product specification. 8.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must 2. be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

7.

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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QR code printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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